

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	126767 7	semiconductor	USPAT ; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 14:49
2	BRS	L2	716	1 and ((wafer or surface) same ((temperatute with condition\$3) or (temperature with control\$4 with distribution)))	USPAT ; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 14:58
3	BRS	L3	2	2 and (heat adj transfer adj plate)	USPAT ; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 14:58
4	BRS	L4	716	1 and ((wafer or surface) same ((temperatute with condition\$3) or (temperature with control\$4 with distribution)))	USPAT ; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 15:05

	Comments	Error Definition	Errors
1			0
2			0
3			0
4			0

	Type	L #	Hits	Search Text	DBs	Time Stamp
5	BRS	L5	2	4 and (heat adj transfer adj plate)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 15:07
6	BRS	L6	159	4 and (heat adj transfer)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 15:04
7	BRS	L7	134263	1 and ((wafer or surface or plate) same ((temperatute with condition\$3) or (temperature with control\$4 with distribution) or heat\$3))	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 15:39
8	BRS	L8	231	7 and (heat adj transfer adj plate)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 15:41

	Comments	Error Definition	Errors
5			0
6			0
7			0
8			0

	Type	L #	Hits	Search Text	DBs	Time Stamp
9	BRS	L9	10	8 and ((upper adj surface) near2 plate)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 15:20
10	BRS	L10	19	8 and inclin\$5	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 15:27
11	BRS	L11	4	9 and inclin\$5	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 15:28
12	BRS	L12	411	7 and (spac\$3 with inclin\$5)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 15:41

	Comments	Error Definition	Errors
9			0
10			0
11			0
12			0

	Type	L #	Hits	Search Text	DBs	Time Stamp
13	BRS	L13	2	12 and (heat adj transfer adj plate)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 15:51
14	BRS	L14	46	12 and (heat adj transfer)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 15:51
15	BRS	L15	81	1 and (heat with plate with (upper adj surface) with wafer)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 16:14
16	BRS	L16	20	15 and (heat adj transfer)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 16:28

	Comments	Error Definition	Errors
13			0
14			0
15			0
16			0

	Type	L #	Hits	Search Text	DBs	Time Stamp
17	BRS	L17	5	16 and (inclination or slope or proclivity or angle or leaning)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 16:48
18	BRS	L18	11405	1 and (wafer with heating)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 16:48
19	BRS	L19	2122	18 and (inclination or slope or proclivity or angle or leaning)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 16:48
20	BRS	L20	7	19 and (heat adj transfer adj plate)	USPAT; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/30 16:49

	Comments	Error Definition	Errors
17			0
18			0
19			0
20			0